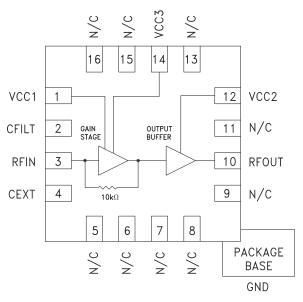
DC - 700 MHz, 10 kOhm TRANSIMPEDANCE AMPLIFIER

Typical Applications

The HMC799LP3E is ideal for:

- Laser Sensor
- FDDI Receiver
- CATV FM Analog Receiver
- Wideband Gain Block
- Low Noise RF Applications

Functional Diagram



Features

10 kOhm Transimpedance

Very Low Noise: 150nA Input RMS Noise

over 700 MHz Bandwidth 700 MHz Analog Bandwidth

Wide Dynamic Range: +65 dB

Low Power: 70mA from Single +5V Supply 16 Lead 3x3 mm SMT Package: 9mm²

General Description

The HMC799LP3E is DC to 700 MHz Transimpedance amplifier designed for opto-electronic laser sensor applications, FDDI receivers and receiver systems employing optical to electrical conversion. This amplifier provides a single-ended output voltage that is proportional to an applied current at its input port. This current is typically provided by a photodiode. Operating from a single +5V supply, HMC799LP3E features very low input referred noise, and very large electrical input dynamic range exceeding 65 dB. 10 kOhm or 80 dB-Ohms transimpedance gain provides very good sensitivity at higher data rates. The output of HMC799LP3E is internally matched to 50 ohms. External matching is not necessary. The HMC799LP3E exhibits excellent gain and output power stability over temperature, while requiring a minimal number of external bias components.

Electrical Specifications, $T_{A} = +25^{\circ}$ C, Vcc1 = Vcc2 = Vcc3 = +5V

v01.1009

Parameter	Conditions	Min.	Тур.	Max.	Units		
DC Specifications	·						
Power Supply Voltage		4.5	5	5.5	V		
Power Supply Current	Vcc = 5V	60	70	80	mA		
Input Impedance	@ 350 MHz		175		Ohm		
Input Bias Voltage			2.1		V		
AC Specifications	AC Specifications						
Transimpedance	@ 100 MHz, RL = 50 Ohm	7.5	10	12.5	k Ohms		
Transimpedance 3-dB Bandwidth		600	700		MHz		
Small Signal Gain	S21		42		dB		
	Cpd [1] <1pF, @ 200 MHz		4.6		pA / √Hz		
January Deferment Comment Nation Describe.	Cpd ^[1] = 1pF, @ 200 MHz		4.8		pA / √Hz		
Input Referred Current Noise Density	Cpd [1] = 2pF, @ 200 MHz		5.2		pA / √Hz		
	Cpd ^[1] = 3pF, @ 200 MHz		5.6		pA / √Hz		

[1] Cpd is the total parasitic capacitance value arises from addition of input photo diode. This value includes photo diode parasitic capacitance, PCB trace capacitance and package parasitic capacitance.



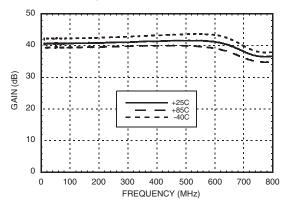


DC - 700 MHz, 10 kOhm TRANSIMPEDANCE AMPLIFIER

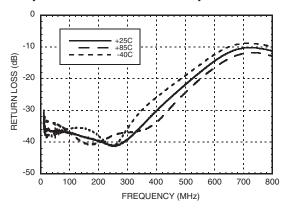
Electrical Specifications (Conditions)

Parameter	Conditions	Min.	Тур.	Max.	Units
	Cpd [1] <1pF, @ 700 MHz BW		149		nA RMS
Level Deferred DMC Comment Nation	Cpd [1] = 1pF, @630 MHz BW		164		nA RMS
Input Referred RMS Current Noise	Cpd [1] = 2pF, @ 560 MHz BW		174		nA RMS
	Cpd [1] = 3pF, @ 420 MHz BW		132		nA RMS
Saturated Output Swing	Vin = 50mV p-p		1		Vp-p
Output Power 1-dB Compression	OP1dB @ 200 MHz		4		dBm
Output Third Order Intercept Point	OIP3 @ 200 MHz		13		dBm
Input Overdrive Current			20		mA
Output Return Loss	@ 500 MHz	16	20		dB

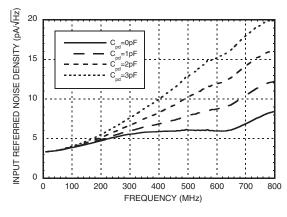
Gain vs. Temperature



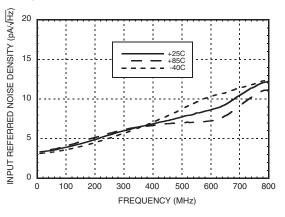
Output Return Loss vs. Temperature



Input Referred Noise Density vs. Cpp [1]



Input Referred Noise Density vs. Temperature [2]



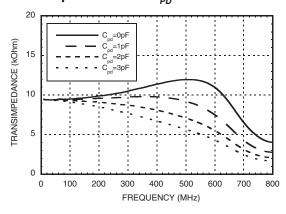
[1] Cpd is the total parasitic capacitance value resulting from the addition of the input photo diode. This value includes photo diode parasitic capacitance, PCB trace capacitance and package parasitic capacitance.
[2] Cpd = 1 pF

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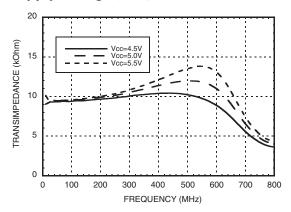


Transimpedance vs. $C_{PD}^{[1]}$

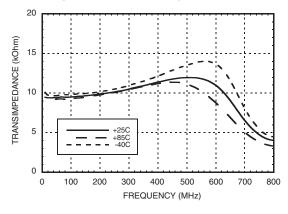


DC - 700 MHz, 10 kOhm TRANSIMPEDANCE AMPLIFIER

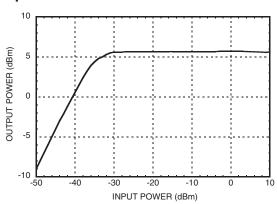
Transimpedance vs. Supply Voltage (Vcc) [2]



Transimpedance vs. Temperature [2]



Output Power vs. Input Power @ 200 MHz [2]



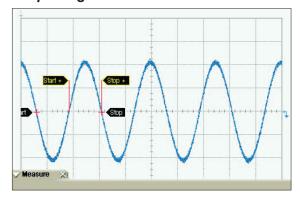
[1] Cpd is the total parasitic capacitance value resulting from the addition of the input photo diode. This value includes photo diode parasitic capacitance, PCB trace capacitance and package parasitic capacitance.
[2] Cpd = 1 pF





DC - 700 MHz, 10 kOhm TRANSIMPEDANCE AMPLIFIER

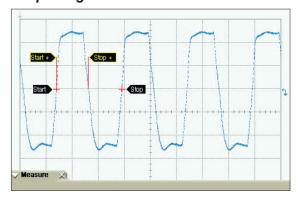
Output Signal [1]



	Measurements					
	Current	Mean	std dev	Min.	Max	Units
V amptd	198.84	200.50	3.6253	184.99	212.70	mV
Frequency	200.8	199.9	0.631	198.0	202.1	MHz
Duty Cycle	50.9	49.7	0.62	47.6	51.6	%

[1] Input signal current 25 μ Ap-p, frequency 200 MHz

Output Signal [2]



	Measurements					
	Current	Mean	std dev	Min.	Max	Units
V amptd	959.62	960.47	3.703	953.11	972.63	mV
Frequency	200.1	200.0	0.117	199.5	200.4	MHz
Duty Cycle	49.1	49	0.08	48.7	49.2	%

[2] Input signal current 20 mAp-p, frequency 200 MHz



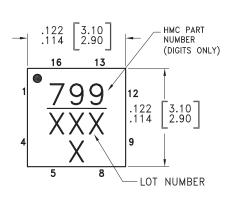


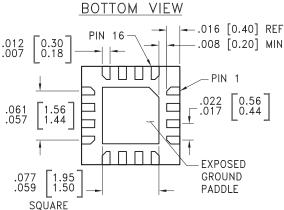
DC - 700 MHz, 10 kOhm TRANSIMPEDANCE AMPLIFIER

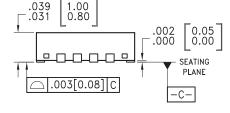
Absolute Maximum Ratings

Power Supply Voltage (Vcc1, Vcc2, Vcc3)	-1V to 8V
Input Current	30 mAp-p
Junction Temperature	125 °C
Continuous Pdiss (T=85 °C) (derate 31.82 mW/ °C Above +85 °C	1.27W
Thermal Resistance (Junction to ground paddle)	31.43 °C/W
Storage Temperature	-65 to 125 °C
Operating Temperature	-40 to +85 °C
ESD Sensitivity (HBM)	Class 1C

Outline Drawing







NOTES:

- 1. LEADFRAME MATERIAL: COPPER ALLOY
- 2. DIMENSIONS ARE IN INCHES [MILLIMETERS].
- 3. LEAD SPACING TOLERANCE IS NON-CUMULATIVE
- 4. PAD BURR LENGTH SHALL BE 0.15mm MAXIMUM. PAD BURR HEIGHT SHALL BE 0.05mm MAXIMUM.
- 5. PACKAGE WARP SHALL NOT EXCEED 0.05mm.
- 6. ALL GROUND LEADS AND GROUND PADDLE MUST BE SOLDERED TO PCB RF GROUND.
- 7. REFER TO HMC APPLICATION NOTE FOR SUGGESTED PCB LAND PATTERN.

Package Information

Part Number	Package Body Material	Lead Finish	MSL Rating	Package Marking [1]
HMC799LP3E	RoHS-compliant Low Stress Injection Molded Plastic	100% matte Sn	MSL1 [2]	<u>H799</u> XXXX

^{[1] 4-}Digit lot number XXXX

^[2] Max peak reflow temperature of 260 °C





DC - 700 MHz, 10 kOhm TRANSIMPEDANCE AMPLIFIER

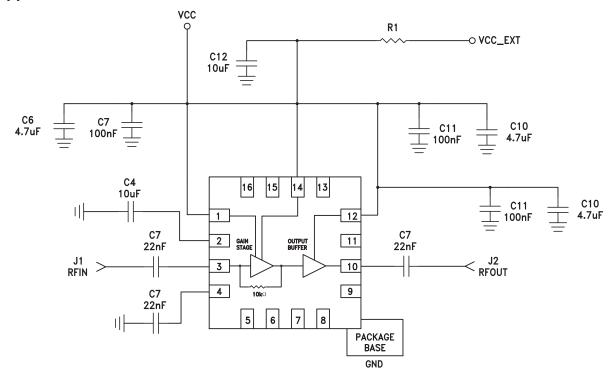
Pin Descriptions

Pin Number	Function	Description	Interface Schematic
1, 12, 14	VCC1, VCC2, VCC3	Positive Supply	
2	CFILT	Overload current filter capacitance pin.	28k CFILT 22k
3	RFIN	RF Input	RFIN O
4	CEXT	Reference voltage filter capacitance pin.	CEXT O TO
5 - 9, 11, 13, 15, 16	N/C	Not connected.	
10	RFOUT	RF Output	500 RFOUT
Package Base	GND	Package base has exposed metal ground paddle which must be connected to ground.	⊖ GND =



DC - 700 MHz, 10 kOhm TRANSIMPEDANCE AMPLIFIER

Application Circuit



Note:

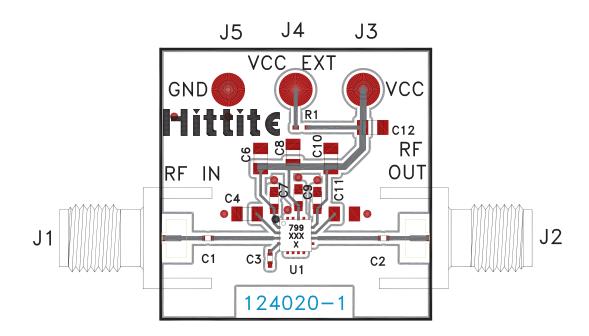
For power supply rejection ratio (PSRR) tests, install 0 Ohm for R1.





Evaluation PCB

DC - 700 MHz, 10 kOhm TRANSIMPEDANCE AMPLIFIER



List of Materials for Evaluation PCB 124022 [1]

Item	Description
J1 - J2	PCB Mount SMA Connector
J3, J5	DC Pin
C1 - C3	22 nF Capacitor, 0402 Pkg.
C4, C12	10 μF Capacitor, 0805 Pkg.
C6, C8, C10	4.7 μF Capacitor, 0805 Pkg.
C7, C9, C11	0.1 μF Capacitor, 0603 Pkg.
U1	HMC799LP3E Transimpedance Amplifier
PCB [2]	124020 Evaluation PCB

^[1] Reference this number when ordering complete evaluation PCB

The circuit board used in the final application should use RF circuit design techniques. Signal lines should have 50 ohm impedance while the package ground leads and exposed paddle should be connected directly to the ground plane similar to that shown. A sufficient number of via holes should be used to connect the top and bottom ground planes. The evaluation circuit board shown is available from Hittite upon request.

^[2] Circuit Board Material: Arlon 25FR or Rogers 4350